Microstructure and fracture mechanism of Cu-Y$_2$O$_3$ composite

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Abstract

This work aimed to examine the structure of Cu-Y$_2$O$_3$ composite, analyse the fracture mechanism, and propose the model of fracture. The in-situ tensile test in SEM was used for direct observation of the process of deformation and fracture. Microscopic analysis revealed that Cu matrix grains are spherical with a mean diameter of $\sim$ 500 nm. EDX and selected area electron diffraction confirmed the presence of Y$_2$O$_3$ particles. Particles can be divided, according to the size, into two categories: smaller A (up to 20 nm) and more significant B (20–100 nm). The in-situ tensile test in SEM showed that the first cracks were created on the particle-matrix interfaces and in the triple point. Subsequent coalescence was observed, and we assumed that the cracks propagate along the grain boundaries. The fracture surface has a transcrysalline ductile character. Based on the in-situ observations and analysis, we proposed the model of fracture mechanism.

Keywords: Cu composite, Y$_2$O$_3$, high-resolution scanning transmission electron microscopy (HRSTEM), structure, fracture mechanism

1. Introduction

Recently, materials with specific properties have attracted a lot of attention. Today, advanced materials that are characterised not only by unique properties such as high strength, excellent conductivity, superior softening resistance, thermal or chemical resistance but also by a combination of these properties are required. The researchers try to achieve the desired unique properties by a combination of different matrices (Cu, Al, Mg, ...) and secondary phases (Al$_2$O$_3$, TiO, Y$_2$O$_3$, SiC, ThO$_2$, CNT, fullerences, ...) [1–5]. Composites with unique properties can be prepared by various techniques; the bases include casting and powder metallurgy [6–9]. Carro et al. [10] fabricated Cu-Y$_2$O$_3$ dispersion strengthened composite by two different routes: casting and powder metallurgy (cryomilling and mechanical alloying). They found that the powder metallurgy route compared with the casting presents a significant dispersion of oxide nanoparticles inside the copper grains, the smallest grain size, and the highest microhardness. The potential of rapid solidification in Y$_2$O$_3$ dispersion strengthened copper alloy was analysed in work [11]. Authors confirmed that the spatial distribution of the oxide obtained in the internally oxidised powders was far from optimal for dispersion strengthening, even though the individual oxide particles are in the desired size range [11]. It is clear, that in some cases, powder metallurgy is more advantageous because this method makes it possible to combine materials that cannot be prepared by conventional melting methods. Using appropriate conditions of powders treatment it is possible to obtain a good dispersion of secondary phase in the matrix.

Copper is one of the essential materials in terms of high electrical and thermal conductivity. But pure copper is not suitable for use at higher temperatures, mainly due to its low strength. A lot of works have been focused on finding a suitable combination of copper matrix and reinforcing phase to achieve proper strength at elevated temperatures [11–13]. Copper-
-based materials, in combination with the appropriate secondary phase, can also provide an optimal combination of good electrical conductivity and superior softening resistance [14–17]. Notably, a combination of Cu and Y₂O₃, Al₂O₃, or other rare metals is suitable for their excellent thermodynamic stability. Yttrium oxide is one of the promising materials for improving the properties of the Cu matrix. It is often used as a single secondary phase or in combination with other oxides as Al₂O₃, TiB + Y₂O₃, La₂O₃, Al₂O₃ + Y₂O₃ + CaO, Y₂O₃ + ZrO₂, TiB + TiC + Y₂O₃ [2, 3, 5, 7, 19, 20].

The chemical, physical and mechanical properties of dispersion strengthened composites and the methods of their improvement are well known. At the same time, a little attention has been paid on the mechanism of fracture. The study of cracks initiation and analysis of the processes/ways of their propagation can help better understand the interfacial interactions, the influence of the morphology of the matrix grains and particles on fracture mechanism of composite materials prepared by powder metallurgy route. The method of the “in-situ” tensile test in SEM is the best method for investigations of fracture mechanisms because it enables us to observe and document deformation processes directly. Thank to which, the initiation and development of the plastic deformation, initiation of cracks, and final fracture can be observed in real-time and reliably described.

This work aimed to characterise the structures of Cu-Y₂O₃ composite and also to analyse the distribution, shape and size of Y₂O₃-phase. Based on the “in-situ” observation of fracture mechanism of Cu-Y₂O₃ composite system, also try to propose the damage model concerning the presented phase.

2. Materials and methods

The method of mechanical alloying was used for preparing of Cu-Y₂O₃ composite material. The copper powder and 2 wt.% (3.54 vol.%) of Y₂O₃ powder, with the grain size of ~75 µm and 20–50 µm, respectively, were milled in an attritor under a protective atmosphere of argon (99.96%) at 600 rpm for 16 h. The received mixture of powders was subsequently compacted by cold pressing, hot extrusion at 750–800°C, and sintering.

For the investigation, very small flat tensile test pieces, with 0.15 mm thickness were prepared by electro erosive machining, keeping the loading direction identical to the direction of extrusion, Fig. 1.

The specimens were ground and polished down to a thickness of approximately 0.1 mm. Finally, the specimens were polished by ion beam milling with PIPS instrument. The test pieces were fitted into the special deformation grips in the electron micro-

Fig. 1. Tensile test specimen.

scope Jeol SEM 5310, which enabled direct observation of the deformation. Based on direct observation of both the deformation and failure processes of the test pieces, it was possible to detect the crack initiation and propagation. Quantitative and qualitative analyses of secondary phases and matrix were realised using metallography, scanning electron microscopy (SEM), energy-dispersive X-ray spectroscopy (EDX), transmission electron microscopy (TEM), electron diffraction.

Fig. 2. The microstructure of the composite (a) with a detail of the homogeneous Y₂O₃ particles distribution (b).
3. Results and discussion

The microstructure of prepared composite mate-
rial can be seen in Fig. 2. COMPO mode material contrast in the scanning electron microscopy shows a homogeneous distribution of secondary $\text{Y}_2\text{O}_3$-phase in Cu matrix. However, at higher magnification particle clustering is evident also.

The detailed sight on matrix grains and $\text{Y}_2\text{O}_3$ particles shape, size, and distribution in the matrix is in Fig. 3. HRSTEM with EDS mapping was used to identify the micro- and nanoparticles of $\text{Y}_2\text{O}_3$ in the Cu matrix. The spherical Cu matrix grain size with a mean diameter of $\sim 500\text{ nm}$ is also evident from the dark field image Fig. 3b. The HAADF detector shows the material contrast, which results in a better view of the $\text{Y}_2\text{O}_3$ particles. The particle distribution is also evident from the EDX map, showing the Y element, Fig. 3c. HRSTEM observation revealed the presence of spherical particles located inside the Cu grains as well as on grain boundaries. It is also evident that the two categories of particles are presented: category A – small particles up to $20\text{ nm}$, and category B – larger particles from $20\text{–}100\text{ nm}$.

Crystallographic identification was examined with TEM. SAED pattern reveals us the Cu matrix with cubic lattice in the zone axis of $[1\,0\,1]$, Fig. 4a. The identified $\text{Y}_2\text{O}_3$ nanoparticle with SAED has a cubic crystal structure rotated to the zone axis of $[1\,0\,0]$. There is evident micro-porosity between the clustered particles of $\text{Y}_2\text{O}_3$ on the Cu matrix grain boundary, Fig. 4c. STEM, Fig. 4d, reveals atomic resolution from the $\text{Y}_2\text{O}_3$ particle with tight and consistent particle-matrix interface without any reaction phase.

The deformation process started the damage by forming cavities in the middle of the specimen, Fig. 5. Most likely damage starts in the triple point and matrix particles interface. The increasing of the load caused grove of cavities by subsequent decohesion of $\text{Y}_2\text{O}_3$ particles and also widening of cracks on matrix grains boundaries. Since the volume fraction of $\text{Y}_2\text{O}_3$ particles is small, their distribution does not influence the trajectory of the fracture. We assume that in this case, the grain boundaries play a fundamental role. In the final phase of the fracture, the crack propagates along the grain boundaries.

Decohesion on the matrix-particles interface is a result of different physical properties of phases presented in the system. The Cu matrix has significantly higher thermal expansion coefficient and lower elastic modulus ($\alpha = 17.0 \times 10^{-6}\text{ K}^{-1}$, $E = 129.8\text{ GPa}$) than $\text{Y}_2\text{O}_3$ ($\alpha = 10.0 \times 10^{-6}\text{ K}^{-1}$, $E = 162\text{ GPa}$). Large differences in the thermal expansion coefficients result in high-stress gradients, which arise on the interphase boundaries during the hot extrusion. Since $\alpha_{\text{matrix}} > \alpha_{\text{particle}}$, high compressive stresses can be expected. However, because the stress gradients arise due to the temperature changes, during cooling (which increases the stress peaks), their partial relaxation can occur. Superposition of the external load and the internal stresses can initiate cracking at interphase boundaries. This is in accordance also with the dislocation theories which argue that the particles in the composite may cause an increase in the dislocation density as a result of thermal strain mismatch between the ceramic particles and the matrix during preparation and/or thermal treatment. In our case, the coefficient of thermal expansion of the matrix is higher than that of the secondary particles and the resulting thermal tension may relax around the matrix-particle interfaces by emitting dislocations.

According to the initiation and propagation of the cracks observed during the in-situ process of deformation, we tried to propose the model of fracture mechanism, Fig. 6. The three steps of cracks initiation, prop-
agation, and coalescence are shown in Fig. 6:

a) the microstructure of the initial state – Cu matrix grains ~ 500 nm in diameter, two categories of particles: A – smaller, up to 20 nm and B – larger, 20–100 nm in diameter,

b) increasing of the tensile load caused the formation of the local cracks, Fig. 5, predominantly on the matrix-particles interface,

c) the further increase of the deformation caused propagation and coalescence of the cracks preferentially along with the particle-matrix interface, triple points, grain boundaries and residual micropores.

Figure 7 shows the fracture surface morphology of Cu-Y$_2$O$_3$ composite and the detail of dimples on the fracture surface. It is evident that fracture surface, Fig. 7, had the transcrysalline ductile character. A
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large number of dimples with heterogeneous size distribution are apparent, arising from secondary particles. Still, no particles are evident inside the dimples, which confirms our assumption about the decohesion of particles. The main diameter of dimples was evaluated (approximately 150–200 dimples were measured), the large dimples (≈ 250 nm) were created on large particles category B, smaller dimples (≈ 60 nm) on the particles category A. According to Gurland-Plateau theory [20], the ductile fracture has three stages: initiation, growth, and coalescence of cavities. Based on the analysis, it can be assumed that cracks were created on the particle-matrix interfaces and in the triple point [21].

4. Conclusions

In this work, the structure and its influence on deformation behaviour and fracture mechanism of Cu\(^{2+}\)-Y\(_2\)O\(_3\) composite were analysed. The analysis of the composite structure showed that the particle size distribution are homogeneously distributed, and the two size categories were determined: A – up to 20 nm and B – 20–100 nm. The “in-situ” tensile test in SEM provides the possibility of direct observation of the deformation processes taking place during loading. Based on the results, the model of the fracture mechanism of Cu-Y\(_2\)O\(_3\) composite was proposed. The final crack had transcristalline ductile character.

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